Surface Mount

Bandpass Filter

CBP-770C+

50Ω 760 to 780 MHz

Generic photo used for illustration purposes only
CASE STYLE: MP1766

The Big Deal

- Narrow bandwidth
- Excellent Rejection
- High power handling
- Miniature shielded package

Product Overview

CBP-770C+ is a ceramic-coaxial-resonator based bandpass filter in a shielded package fabricated using SMT technology. This filter offers outstanding close in rejection, low insertion loss and high power handling for use in wireless control systems.

Key Features

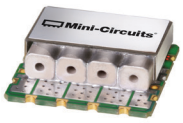
Feature	Advantages
High Selectivity	The CBP-770C+ filter incorporates High-Q ceramic resonators that enables sharp rejection near passband.
Low Passband VSWR	This filter maintains typical VSWR over passband frequency range making this filter easier to integrate into receiver and transmitter RF chains with less concerns for in band frequency ripple.
Rugged construction	The CBP-770C+ has been qualified over wide range of thermal, mechanical and environmental conditions including withstanding the stress of extensive solder reflow cycles.

Surface Mount

Bandpass Filter

50Ω 760 to 780 MHz

CBP-770C+



Generic photo used for illustration purposes only
CASE STYLE: MP1766

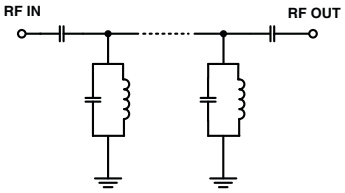
Features

- Narrow bandwidth
- Excellent rejection
- High selectivity
- High power handling
- Miniature shielded package

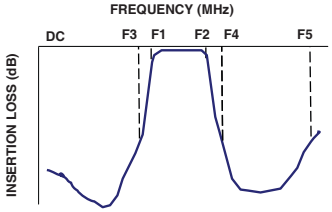
Applications

- Wireless control system (WCS)
- Amateur radio bands
- Mobile test system
- Public safety services

Functional Schematic



Typical Frequency Response



+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Electrical Specifications at 25°C

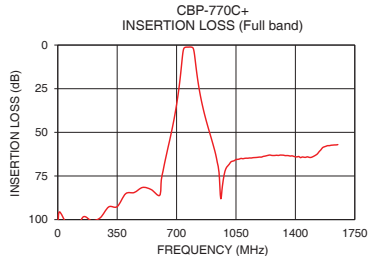
Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	—	—	—	770	—	MHz
	Insertion Loss	F1-F2	760-780	—	1.0	2.0	dB
	VSWR	F1-F2	760-780	—	1.24	2.1	:1
Stop Band, Lower	Insertion Loss	DC-F3	DC-705	20	29	—	dB
	VSWR	DC-F3	DC-705	—	20	—	:1
Stop Band, Upper	Insertion Loss	F4-F5	840-1650	20	27	—	dB
	VSWR	F4-F5	840-1650	—	20	—	:1

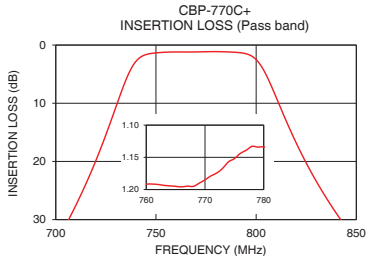
Maximum Ratings	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power Input	10W

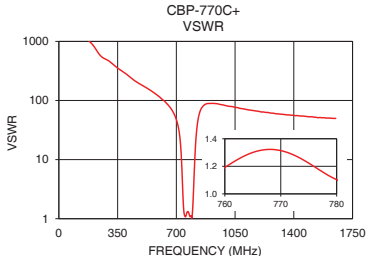
Permanent damage may occur if any of these limits are exceeded.

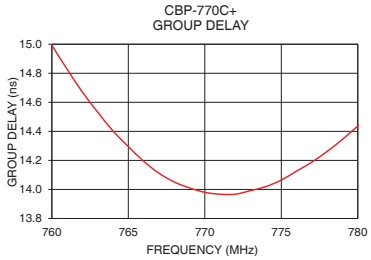
Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Group Delay (nsec)
1	102.23	29634.56	760	14.99
500	81.57	178.11	762	14.67
650	58.48	84.53	763	14.53
705	30.93	42.72	764	14.40
719	20.69	26.55	765	14.30
730	10.65	10.80	766	14.19
739	3.27	2.60	767	14.11
745	1.64	1.31	768	14.05
760	1.19	1.19	769	14.01
770	1.18	1.31	770	13.98
780	1.13	1.10	771	13.97
795	1.50	1.18	772	13.97
802	3.34	2.82	773	13.99
810	8.98	10.18	774	14.02
825	20.27	39.30	775	14.06
840	28.90	63.63	776	14.13
843	30.40	67.60	777	14.19
1000	69.42	81.18	778	14.26
1400	64.00	56.00	779	14.35
1650	57.04	49.83	780	14.44







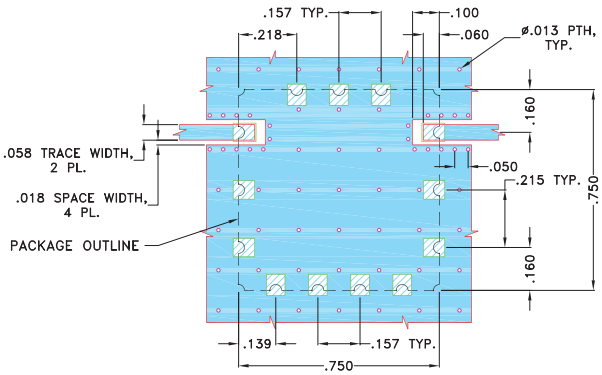


Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

INPUT	1
OUTPUT	10
GROUND	2,3,4,5,6,7,8,9,11,12,13

Demo Board MCL P/N: TB-684+
Suggested PCB Layout (PL-373)



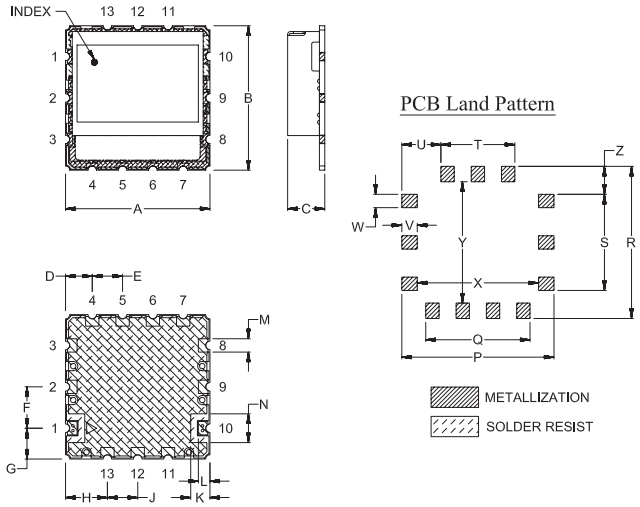
NOTES:

1. TRACE WIDTH IS SHOWN FOR OAK (OAK-602) WITH DIELECTRIC THICKNESS .022"±.0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

Outline Drawing



Outline Dimensions (inch / mm)

A	B	C	D	E	F	G	H	J	K	L	M	N
.750	**.750**	**.210**	**.139**	**.157**	**.215**	**.160**	**.218**	**.157**	**.100**	**.060**	**.069**	**.149**
19.05	19.05	5.33	3.53	3.99	5.46	4.06	5.54	3.99	2.54	1.52	1.75	3.78

P	Q	R	S	T	U	V	W	X	Y	Z		wt,
.790	**.541**	**.790**	**.499**	**.384**	**.203**	**.080**	**.069**	**.630**	**.630**	**.145**		grams
20.07	13.74	20.07	12.67	9.75	5.16	2.03	1.75	16.00	16.00	3.68		4.6

Note: Please refer to case style drawing for details

Band Pass Filter CBP-770C+

Typical Performance Data

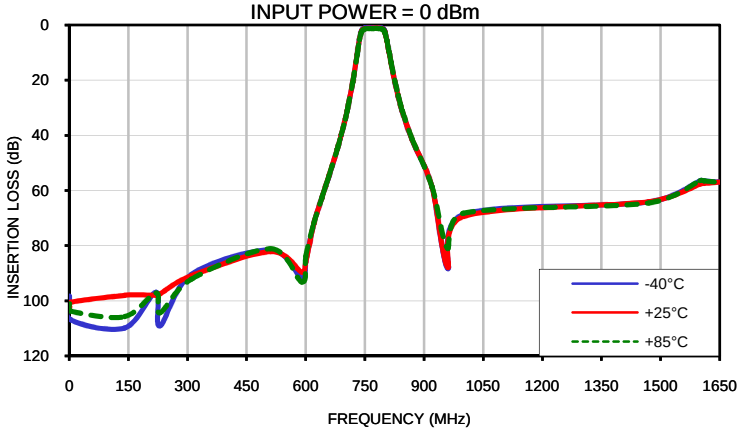
FREQ.	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
(MHz)	(dB)			(dB)			(dB)		
	@-40°C	@+25°C	@+85°C	@-40°C	@+25°C	@+85°C	@-40°C	@+25°C	@+85°C
1	98.28	102.23	101.11	0.00	0.00	0.00	0.00	0.00	0.00
4	106.86	100.47	103.72	0.00	0.00	0.00	0.00	0.00	0.00
140	109.88	98.04	105.75	0.00	0.01	0.02	0.00	0.01	0.01
220	96.90	98.02	97.16	0.01	0.02	0.03	0.01	0.03	0.03
230	109.06	97.48	104.33	0.01	0.02	0.03	0.01	0.03	0.03
310	90.43	90.92	92.18	0.02	0.04	0.05	0.02	0.04	0.05
510	81.60	82.15	81.13	0.07	0.10	0.12	0.08	0.12	0.13
590	91.75	89.64	93.16	0.10	0.15	0.17	0.12	0.17	0.19
600	85.89	86.13	83.95	0.11	0.15	0.17	0.13	0.18	0.20
620	72.23	72.21	72.12	0.12	0.17	0.19	0.15	0.20	0.22
640	62.97	62.91	62.88	0.14	0.19	0.22	0.17	0.22	0.24
650	58.65	58.48	58.53	0.15	0.21	0.23	0.18	0.24	0.26
660	54.40	54.25	54.18	0.17	0.22	0.25	0.20	0.26	0.28
680	45.09	44.98	44.98	0.21	0.27	0.30	0.24	0.31	0.34
690	39.92	39.81	39.83	0.24	0.31	0.34	0.28	0.35	0.38
700	34.20	34.08	34.10	0.29	0.36	0.40	0.33	0.41	0.45
705	31.06	30.93	30.97	0.33	0.41	0.45	0.37	0.46	0.49
706	30.41	30.28	30.31	0.33	0.42	0.46	0.38	0.47	0.50
719	20.80	20.69	20.76	0.54	0.65	0.72	0.60	0.72	0.78
730	10.67	10.65	10.79	1.39	1.61	1.72	1.52	1.75	1.85
736	5.06	5.20	5.38	3.76	4.13	4.26	4.02	4.42	4.56
740	2.58	2.81	3.00	7.95	8.39	8.51	8.51	9.04	9.18
742	1.90	2.15	2.33	11.15	11.59	11.68	12.09	12.68	12.80
743	1.68	1.93	2.10	13.00	13.43	13.51	14.24	14.86	15.00
745	1.40	1.64	1.80	16.98	17.37	17.46	19.12	19.94	20.18
747	1.24	1.48	1.63	20.70	21.12	21.30	23.64	24.88	25.53
750	1.12	1.35	1.48	24.52	25.19	25.68	25.35	26.48	27.25
760	1.00	1.19	1.31	20.69	21.17	21.23	19.97	20.36	20.36
767	1.01	1.19	1.31	16.66	17.21	17.16	16.74	17.30	17.22
770	1.00	1.18	1.30	16.75	17.35	17.26	17.00	17.64	17.51
772	0.99	1.17	1.29	17.37	18.01	17.87	17.78	18.48	18.31
780	0.94	1.13	1.24	25.51	26.15	25.82	30.84	33.01	31.90
784	0.96	1.16	1.27	26.86	26.93	27.07	30.38	30.21	31.10
786	0.98	1.19	1.30	25.45	25.70	25.74	26.06	26.24	26.57
790	1.04	1.26	1.38	27.29	28.33	27.37	24.00	24.47	24.40
791	1.07	1.29	1.41	30.20	31.94	29.96	24.07	24.50	24.48
793	1.13	1.36	1.48	37.57	35.30	38.21	22.84	22.89	23.46
796	1.35	1.61	1.71	18.29	18.01	19.25	16.24	16.16	17.08
797	1.48	1.75	1.85	15.30	15.16	16.20	13.99	13.97	14.83
798	1.67	1.94	2.02	12.84	12.80	13.70	11.96	11.99	12.78
799	1.91	2.19	2.25	10.78	10.81	11.60	10.14	10.23	10.95
800	2.21	2.50	2.54	9.02	9.11	9.81	8.56	8.68	9.33
801	2.60	2.88	2.90	7.53	7.66	8.28	7.17	7.33	7.92
802	3.05	3.34	3.33	6.27	6.43	6.98	5.99	6.17	6.70
806	5.60	5.84	5.72	3.01	3.20	3.53	2.88	3.09	3.40
811	9.66	9.80	9.60	1.33	1.49	1.66	1.27	1.44	1.61
812	10.49	10.62	10.42	1.15	1.31	1.46	1.10	1.27	1.41
816	13.75	13.82	13.60	0.71	0.84	0.94	0.68	0.82	0.92
825	20.28	20.27	20.06	0.34	0.44	0.50	0.34	0.45	0.50
834	25.77	25.71	25.51	0.23	0.31	0.36	0.24	0.33	0.37
840	28.98	28.90	28.71	0.20	0.27	0.31	0.21	0.29	0.33
845	31.44	31.35	31.16	0.18	0.25	0.29	0.19	0.27	0.30
870	41.83	41.68	41.52	0.14	0.20	0.23	0.16	0.23	0.26
920	58.88	58.81	58.61	0.14	0.19	0.22	0.17	0.23	0.25
960	88.29	87.87	81.06	0.14	0.20	0.23	0.18	0.24	0.26
1000	68.66	69.42	68.30	0.16	0.21	0.24	0.19	0.26	0.27
1470	64.24	64.03	64.49	0.27	0.32	0.35	0.28	0.35	0.36
1600	56.49	57.64	56.45	0.28	0.34	0.37	0.29	0.37	0.38
1610	56.57	57.41	56.55	0.28	0.34	0.37	0.29	0.36	0.38
1650	56.97	57.04	57.10	0.28	0.35	0.38	0.28	0.36	0.38

Typical Performance Data

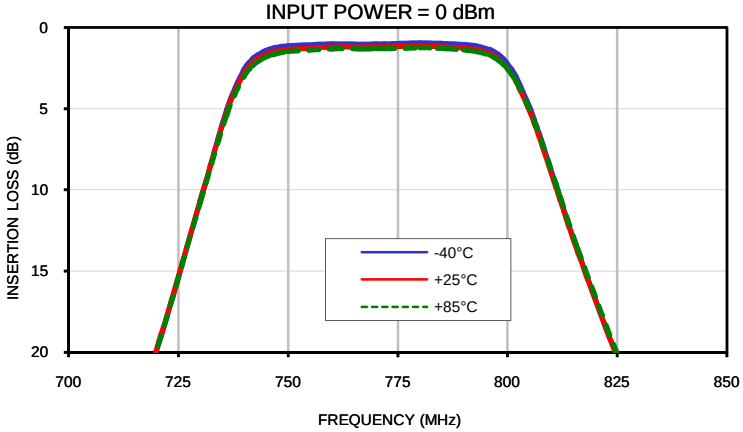
FREQ.	GROUP DELAY		
	(nsec)		
(MHz)	@-40°C	@+25°C	@+85°C
760	15.09	14.99	14.95
761	14.92	14.83	14.79
762	14.75	14.67	14.63
763	14.60	14.53	14.49
764	14.47	14.40	14.36
765	14.36	14.30	14.25
766	14.25	14.19	14.15
767	14.16	14.11	14.06
768	14.10	14.05	14.00
769	14.05	14.01	13.95
770	14.02	13.98	13.92
771	14.01	13.97	13.90
772	14.01	13.97	13.91
773	14.04	13.99	13.92
774	14.07	14.02	13.95
775	14.11	14.06	13.99
776	14.18	14.13	14.05
777	14.25	14.19	14.11
778	14.32	14.26	14.18
779	14.41	14.35	14.26
780	14.50	14.44	14.36

Typical Performance Curves

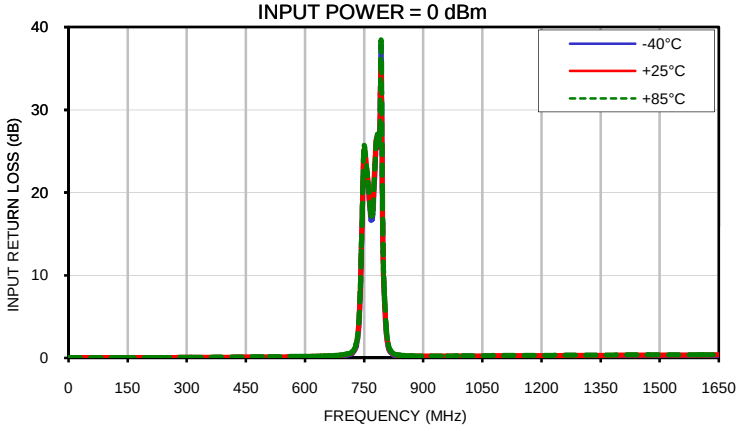
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



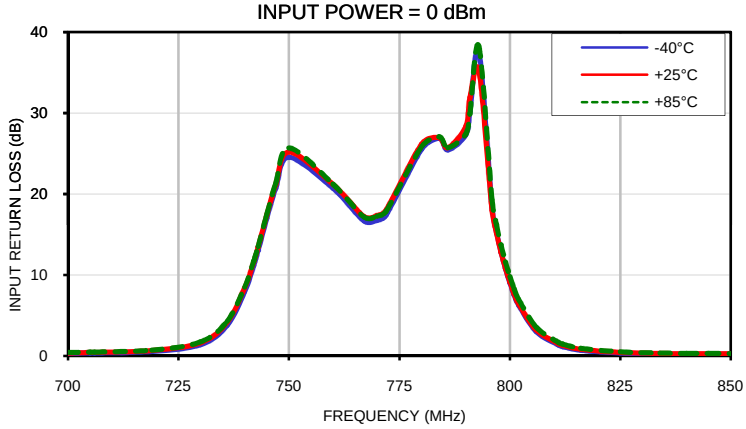
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



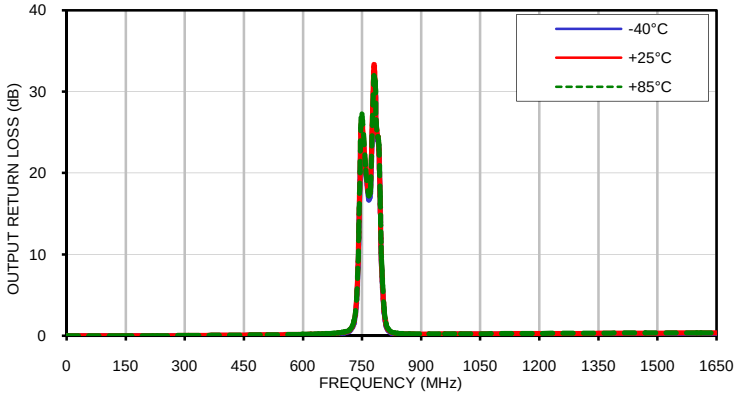
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



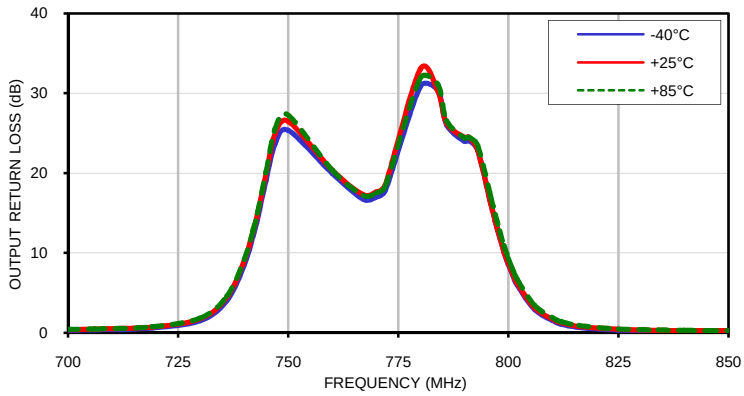
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



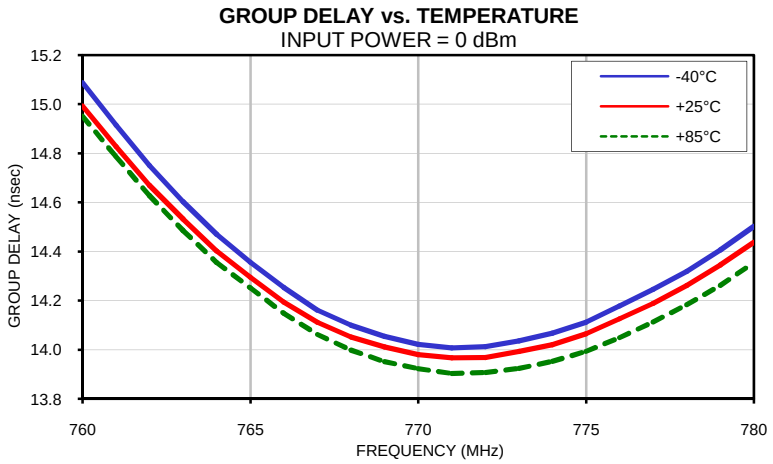
OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



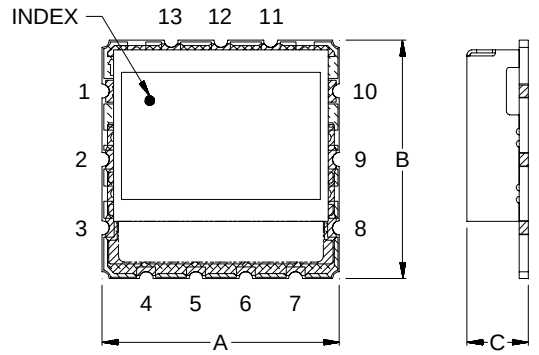
Typical Performance Curves

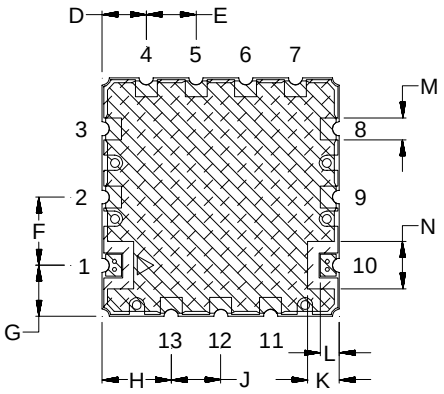


Case Style MP

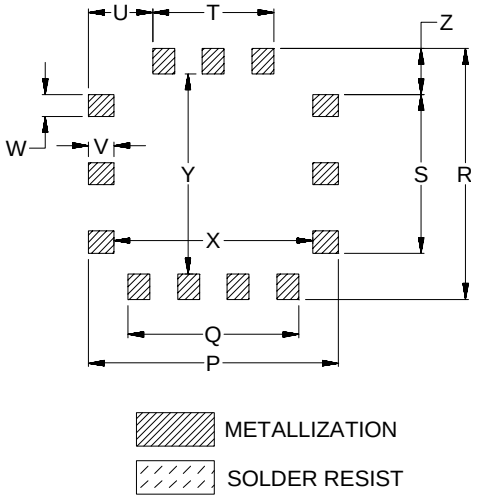
Outline Dimensions

MP1766





PCB Land Pattern



CASE#	A	B	C	D	E	F	G	H	J	K	L	M	N
MP1766	.750 (19.05)	.750 (19.05)	.210 (5.33)	.139 (3.53)	.157 (3.99)	.215 (5.46)	.160 (4.06)	.218 (5.54)	.157 (3.99)	.100 (2.54)	.060 (1.52)	.069 (1.75)	.149 (3.78)

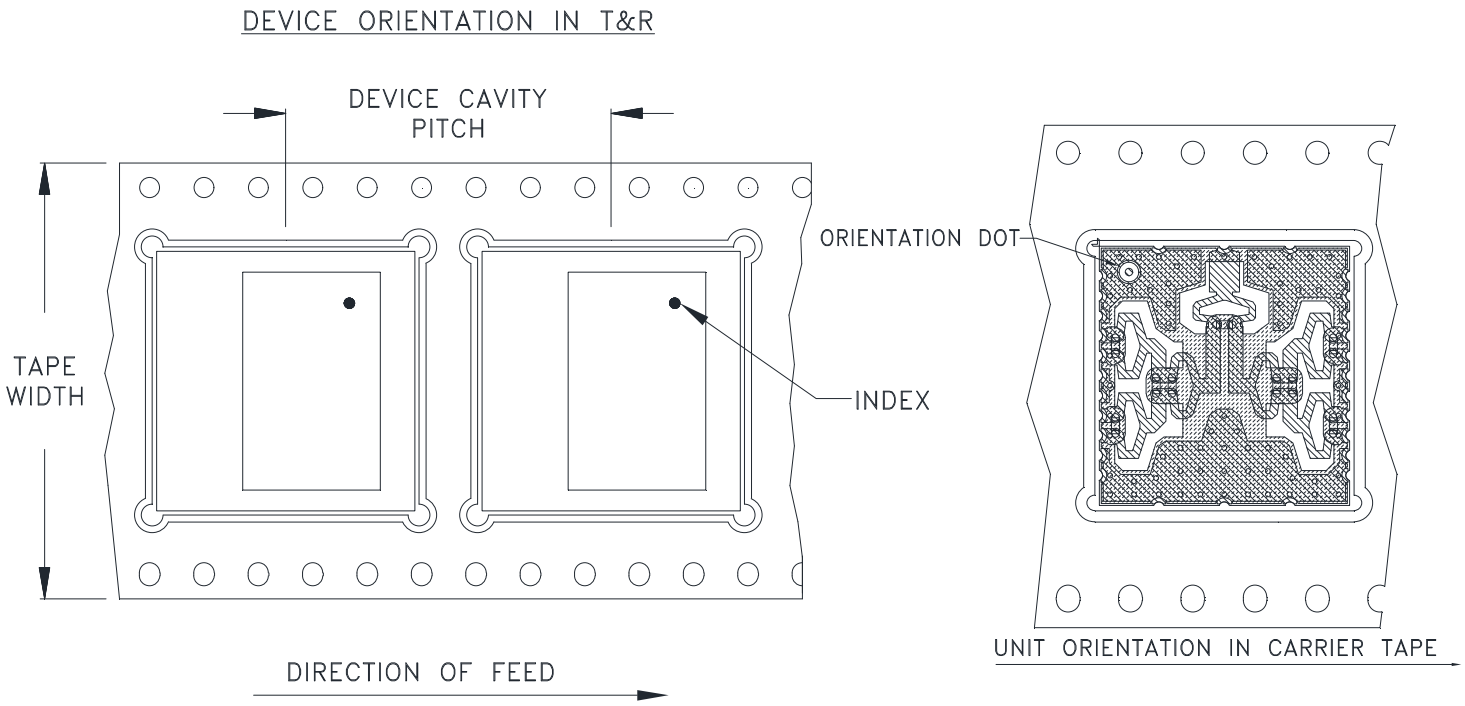
CASE#	P	Q	R	S	T	U	V	W	X	Y	Z	WT.GRAMS
MP1766	.790 (20.07)	.541 (13.74)	.790 (20.07)	.499 (12.67)	.384 (9.75)	.203 (5.16)	.080 (2.03)	.069 (1.75)	.630 (16.00)	.630 (16.00)	.145 (3.68)	4.6

Dimensions are in inches (mm). Tolerances: 2PL. ± .03; 3PL. ± .015

Notes:

1. Case material: Nickel-Silver alloy.
2. Base: Printed wiring laminate.
3. Termination finish:
   For RoHS Case Styles: 2-5 µ inch (.05-.13 microns) Gold over 120-240 µ inch (3.05-6.10 microns) Nickel plate.
   All models, (+) suffix.

Tape & Reel Packaging TR-F111



Applicable Case styles:

Applicable Case styles:RS1539

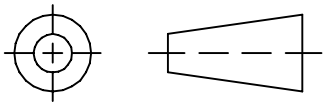
Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
32	24	13	250

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

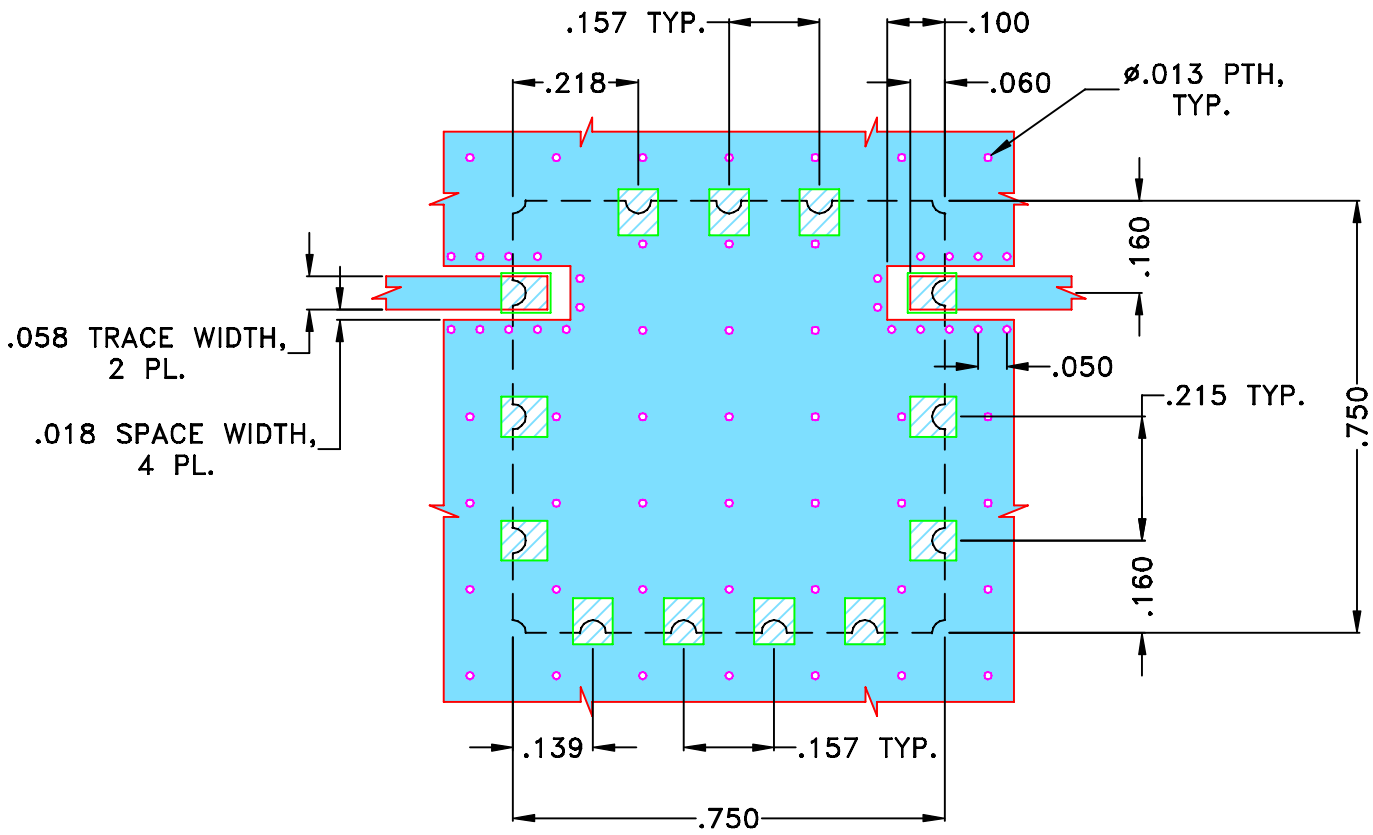
Mini-Circuits®
INTERNET http://www.minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION



REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M137721	NEW RELEASE	JUN 12	DDR	KG

SUGGESTED MOUNTING CONFIGURATION FOR MP1766 CASE STYLE "13FL01" PIN CODE



NOTES:

1. TRACE WIDTH IS SHOWN FOR OAK (OAK-602) WITH DIELECTRIC THICKNESS .022"±.0015". COPPER: 1/2 OZ. EACH SIDE.
   FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	DDR	22 JUN 12
TOLERANCES ON:	CHECKED	MD	22 JUN 12
2 PL DECIMALS ±	APPROVED	GM	22 JUN 12
3 PL DECIMALS ± .005"			
ANGLES ±			
FRACTIONS ±			

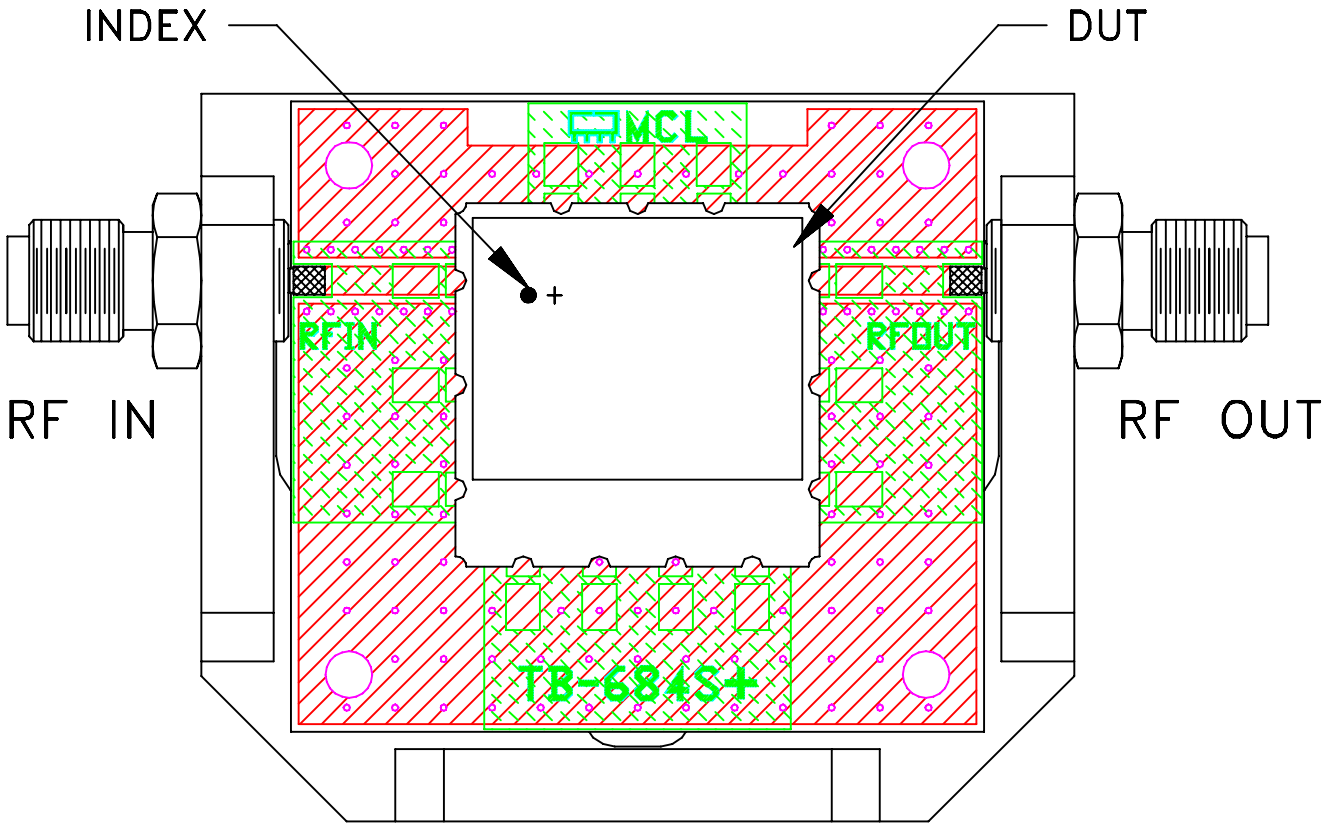
ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

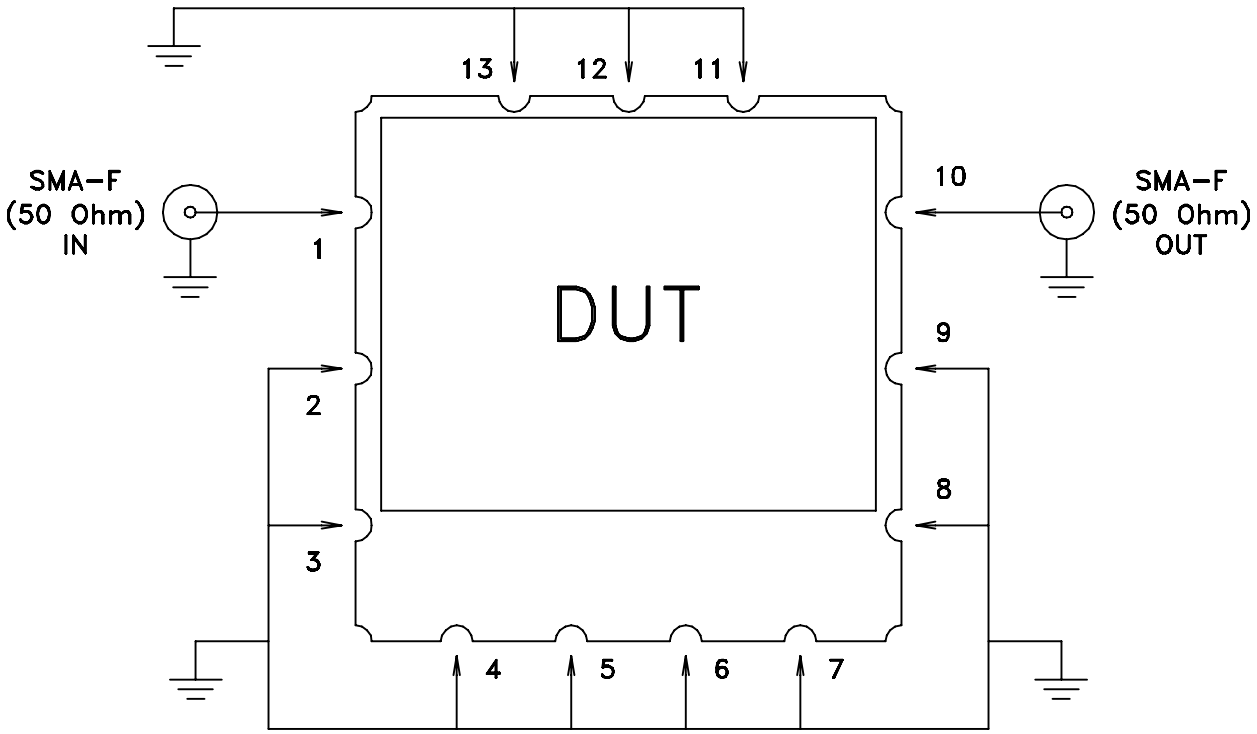
PL, 13FL01, MP1766, BPF, TB-684+, 50 Ohm

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-373	OR
FILE: 98PL373	SCALE: 4:1	SHEET: 1 OF 1	

Evaluation Board and Circuit



TB-684+



Schematic Diagram

Notes:
1. 50 Ohm SMA Female connectors.
2. PCB Material: OAK-602 OR Equivalent
   Dielectric Constant=2.50±.04, Thickness=.022 inch.

Mini-Circuits®

Mini-Circuits

Environmental Specifications ENV54

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 96 hours, 40°C	MIL-STD-202, Method 103B, Condition B, Except 50°C
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process, 245°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 4 times in each of three axes (total 12)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A